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Data sheet 6AG4104-4HM21-0EX2

SIMATIC IPC547G (Rack PC, 19", 4HU); Interfaces: 2x USB 3.0 on the front; 2x Intel Gigabit Ethernet, 2x PS/2, Audio on the rear side; 7 slots: 5x PCI Express, 2x PCI, Temperature and Fan monitoring; Watchdog; Card retainer Core i7-6700 (4C/8T, 3.4 (4.0) GHz, 8 MB cache, iAMT); Mainboard: (chipset C236, 1x DVI-D, 2x display ports V1.2, 4x USB 3.0 and 4x USB 2.0 on the rear side, 1x USB 2.0 internal, 1x COM 1; RAID onboard) RAID1, 480 GB (2x 480 GB SSD) in interchangeable insert, hot-swap, front-side 16 GB DDR4 SD-RAM (2x 8 GB), Dual Channel Enclosure blue chromated, 100/240V AC industrial power supply unit, without removable data storage media Graphics onboard Windows 10 Enterprise 2016 LTSB MUI (en/de/fr/it/es), 64 bit for Core i7/Xeon without expansions (software) Power supply cable USA

General information	
Product type designation	IPC547G
Installation type/mounting	
Mounting	For horizontal and vertical installation; prepared for telescopic rails; 19" mounting bracket can be removed externally; tower kit (optional)
Design	Rack PC, 19", 4U
Supply voltage	
Type of supply voltage	100/240 V AC (autorange) 50 / 60 Hz; optional redundant 100/240 V AC
Line frequency	
● Rated value 50 Hz	Yes
● Rated value 60 Hz	Yes
Mains buffering	
● Mains/voltage failure stored energy time	20 ms
Processor	
Processor type	Xeon E3-1275 v5 (4C/8T, 3.6 (4.0) GHz, 8 MB Cache); Core i7-6700 (4C/8T, 3.4 (4.0) GHz, 8 MB Cache); Core i5-6500 (4C/4T, 3.2 (3.6) GHz, 6 MB Cache); Pentium G4400 (2C/2T, 3.3 GHz, 3 MB Cache)
Chipset	Intel C236 / Intel H110
Graphic	
Graphics controller	Onboard Intel HD graphics P530 / 530 /510 integrated in processor; graphics card PCIe (x16) (dual head: 2x VGA or 2x DVI-D) (optional)
Drives	
Optical drives	DVD±R/RW (SlimLine)
Hard disk	Internal installation: 1 TB HDD, 2x 1 TB HDD, RAID1 (2x 1 TB HDD), RAID1 (2x 1 TB HDD (Enterprise)); for front mounting in low-profile removable drive bay trays (hot-swap in RAID configuration): 1 TB HDD, 2x 1 TB HDD, RAID1 (2x 1 TB HDD), RAID1 (2x 1 TB HDD (Enterprise)), RAID1 (2x 2 TB HDD (Enterprise)), RAID1 (2x 2 TB HDD (Enterprise)) + 1x 2 TB HDD (Enterprise) as hot spare, RAID1 (2x 2 TB HDD (Enterprise)) + 1x 480 GB SSD, RAID5 (3x 2 TB HDD (Enterprise)), RAID5 (3x 2 TB HDD (Enterprise)) + 1x 2 TB HDD(Enterprise) as hot spare
SSD	Yes; 1x 240 GB, 1x 480 GB SSD, 2x 480 GB SSD, RAID1 (2x 480 GB SSD)
Slot for drives	Mounted internally in vibration/shock-absorbing hard disk support, or mounted at the front in the low-profile removable drive bay (hot-swap in RAID configurations)
Storage	
Main memory	4 GB to 64 GB DDR4-2133 SDRAM
Capacity of main memory, max.	64 Gbyte
Interfaces	
Interfaces/bus type	Interfaces mainboard (H110 chipset): 2x Intel Gigabit Ethernet (RJ45, teaming-capable), 4x USB 3.0: 2x on rear, 2x on front, 4x USB 2.0: 4x on rear, 1x DisplayPort V1.2, 1x DVI-D, 2x PS/2, audio: Line in, line out, micro; interfaces mainboard (C236 chip set): 2x Intel Gigabit Ethernet (RJ45, teaming-capable), 6x USB 3.0: 4x on rear, 2x on front, 5x USB 2.0: 4x on rear, 1x internal e.g. for software dongle with optional interlock, 2x DisplayPort V1.2, 1x DVI-D, 1x COM1, 2x PS/2, audio: line in, line out, micro
serial interface	COM1: 1x RS 232, COM2 (optional): 1x RS 232
Video interfaces	

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● Graphics interface	2x DisplayPort and 1x DVI-D onboard; 1x VGA via DP-VGA adapter cable (optional); graphics card PCIe (x16), Dual Head (2x VGA or 2x DVI-D), 1 GB graphics memory (optional)
Industrial Ethernet	
● Industrial Ethernet interface	
— 100 Mbps	Yes
— 1000 Mbps	Yes
Interrupts/diagnostics/status information	
LED status display	POWER, HDD, TEMP, FAN, HDD0 ALARM, HDD1 ALARM, HDD2 ALARM, HDD3 ALARM
Integrated Functions	
Monitoring functions	
● Temperature monitoring	Yes
● Fan	Yes
● Monitoring function via network	Optional
Degree and class of protection	
IP (at the front)	IP30
IP (rear)	IP20
Standards, approvals, certificates	
CE mark	Yes; For use in industrial areas as well as domestic, business and commercial environments (emitted interference: EN 61000-6-3:2007 +A1:2011, noise immunity: EN 61000-6-2:2005)
CSA approval	Yes; CAN/CSA-C22.2 No. 61010-2-201 Second Edition
UL approval	Yes; UL 61010-2-201 Second Edition, File E85972
cULus	Yes; UL 61010-2-201 Second Edition; CAN/CSA-C22.2 No. 61010-2-201 Second Edition
RCM (formerly C-TICK)	Yes
KC approval	Yes
EAC (formerly Gost-R)	Yes
Dust protection	With front door closed: G2 EN 779, 99% of particles > 0.5 mm are filtered
Ambient conditions	
Ambient temperature during operation	
● min.	0 °C
● max.	40 °C
Ambient temperature during storage/transportation	
● min.	-20 °C
● max.	60 °C
Vibrations	
● Vibration resistance during operation acc. to IEC 60068-2-6	Tested according to IEC 60068-2-6, 10 cycles; 20 to 58 Hz: 0.015 mm; 58 to 200 Hz: 2 m/s² (0.2 g)
Operating systems	
pre-installed operating system	Windows 7 Ultimate multi-language (32-bit / 64-bit); Windows 10 Enterprise 2015 LTSB, multi-language (64-bit); Windows 10 Enterprise 2016 LTSB, multi-language (64-bit); Windows 10 IoT Enterprise 2019 LTSC, multi-language (64-bit); Windows Server 2008 R2 Standard Edition incl. 5 multi-language clients (64-bit); Windows Server 2012 R2 Standard Edition incl. 5 multi-language clients (64-bit); Windows Server 2016 Standard Edition incl. 5 multi-language clients (64-bit)
without operating system	Yes
Dimensions	
Width	430 mm
Height	177 mm; 4U
Depth	446 mm; Device with short enclosure: 356 mm
Approvals / Certificates	
General Product Approval	

Miscellaneous | Manufacturer Declaration









General Product Approval

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General Product Approval	Dangerous goods			
		Test Summary Report UN 38.3	Dangerous goods information	Dangerous goods information	Test Summary Report UN 38.3

Environment	
Environmental Confirmations	Environmental Confirmations

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